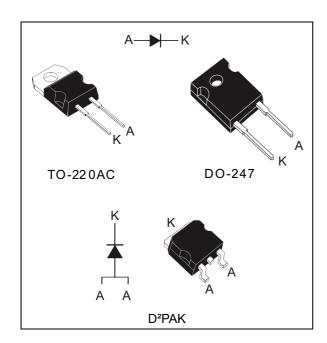
STTH30R04



Ultrafast recovery diode

Datasheet - production data



Description

The compromise-free, high quality design of this diode has produced a device with low leakage current, regularly reproducible characteristics and intrinsic ruggedness. These characteristics make it ideal for heavy duty applications that demand long term reliability.

Table 1. Device summary

Symbol	Value
I _{F(AV)}	30 A
V_{RRM}	400 V
T _{j (max)}	175° C
V _{F (typ)}	0.97 V
t _{rr (typ)}	24 ns

Features

- Ultrafast switching
- Low reverse current
- · Low thermal resistance
- · Reduces switching and conduction losses
- High junction temperature
- ECOPACK[®]2 compliant component

Characteristics STTH30R04

Characteristics 1

Table 2. Absolute ratings (limiting values at 25° C, unless otherwise specified)

Symbol	F	Parameter					
V_{RRM}	Repetitive peak reverse voltage	epetitive peak reverse voltage					
I _{F(RMS)}	RMS forward current	RMS forward current					
I _{F(AV)}	Average forward current, δ = 0.5 TO-220AC / DO-247 / D²PAK T_c = 120 °C				Α		
I _{FRM}	Repetitive peak forward current $t_p = 10 \text{ ms}, F = 1 \text{ KHz}$				Α		
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms Sinusoidal}$				Α		
T _{stg}	Storage temperature range				° C		
T _j	Operating junction temperature rang	je		-40 to +175	° C		

Table 3. Thermal parameters

Symbol	Р	Value	Unit	
R _{th(j-c)}	Junction to case TO-220AC / DO-247 / D²PAK		1.15	°C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min	Тур	Max	Unit
		T _j = 25° C				15	
I _R ⁽¹⁾		T _j = 100° C	$V_R = V_{RRM}$		3	30	μΑ
		T _j = 125° C			15	150	
	V _F ⁽²⁾ Forward voltage drop	T _j = 25° C	I _ 15 A			1.26	
		T _j = 150° C	I _F = 15 A		0.8	1.0	
V _F ⁽²⁾		T _j = 25° C				1.45	V
		T _j = 100° C	I _F = 30 A			1.3	
		T _j = 150° C			0.97	1.2	

^{1.} Pulse test: $t_p = 5$ ms, $\delta < 2\%$

To evaluate the conduction losses use the following equation: P = 0.9 x $I_{F(AV)}$ + 0.01 x $I_{F}^{2}_{(RMS)}$

$$P = 0.9 \text{ x } I_{F(AV)} + 0.01 \text{ x } I_{F}^{2}_{(RMS)}$$

^{2.} Pulse test: t_p = 380 μ s, δ < 2%

STTH30R04 Characteristics

Table 5. Dynamic characteristics

Symbol	Parameter	Parameter Test conditions		Тур	Max	Unit
		$I_F = 1 \text{ A, } dI_F/dt = -200 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25^{\circ} \text{ C}$		24	35	
t _{rr}	t _{rr} Reverse recovery time	$I_F = 1 \text{ A, } dI_F/dt = -15 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25^{\circ} \text{ C}$		78	100	ns
		$I_F = 1 \text{ A}, I_R = 1 \text{ A},$ $I_{RR} = 0.25 \text{ A}, T_j = 25^{\circ} \text{ C}$			50	
I _{RM}	Reverse recovery current	$I_F = 30 \text{ A}, dI_F/dt = -200 \text{ A}/\mu\text{s},$ $V_R = 320 \text{ V}, T_j = 125^{\circ} \text{ C}$		10	14	Α
t _{fr}	Forward recovery time	$I_F = 30 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s},$ $V_{FR} = 1.1 \text{ x } V_{Fmax}, T_j = 25^{\circ} \text{ C}$			500	ns
V _{FP}	Forward recovery voltage	$I_F = 30 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s},$ $V_{FR} = 1.1 \text{ x } V_{Fmax}, T_j = 25^{\circ} \text{ C}$		2.9		٧

Figure 1. Conduction losses versus average current

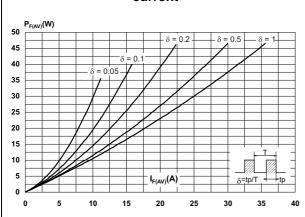


Figure 2. Forward voltage drop versus forward current

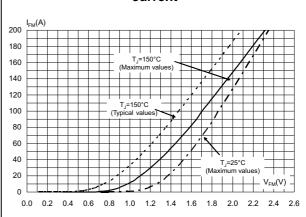


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

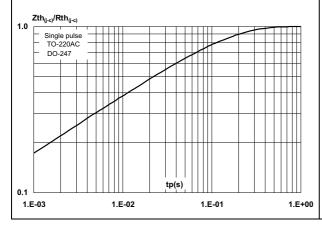
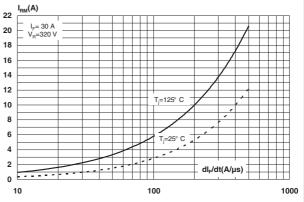
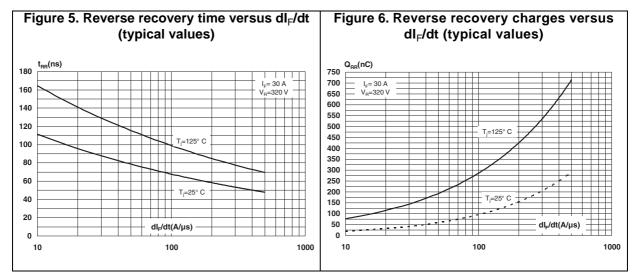
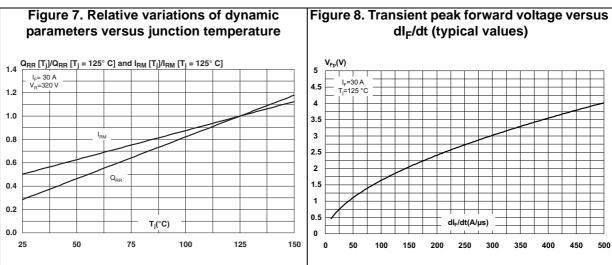


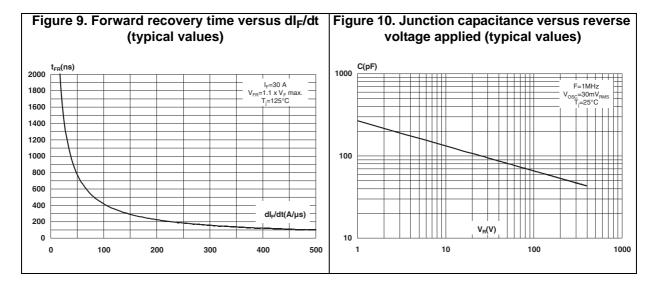
Figure 4. Peak reverse recovery current versus dl_F/dt (typical values)



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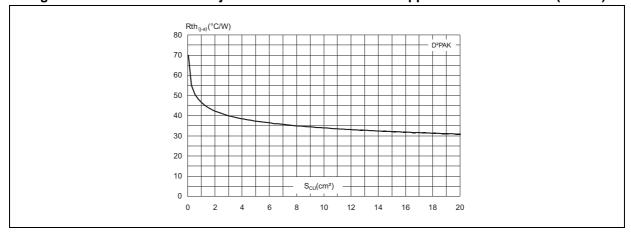






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Figure 11. Thermal resistance junction to ambient versus copper surface under tab (D2PAK)



Package information STTH30R04

Package information 2

- Epoxy meets UL94, V0
- Lead-free package
- Cooling method: by conduction (C)
- Recommended torque value: 0.55 N·m (TO-220AC)
- Maximum torque value: 0.7 N·m (TO-220AC)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

2.1 D²PAK package information

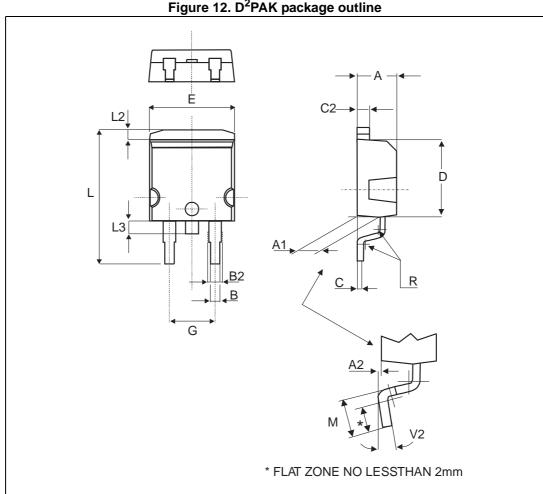
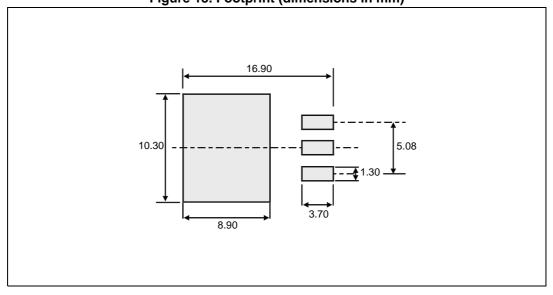


Figure 12. D²PAK package outline

Table 6. D²PAK package mechanical data

		Dime	nsions	
Ref.	Millin	neters	Inc	hes
	Min.	Max.	Min.	Max.
А	4.40	4.60	0.173	0.181
A1	2.49	2.69	0.098	0.106
A2	0.03	0.23	0.001	0.009
В	0.70	0.93	0.027	0.037
B2	1.14	1.70	0.045	0.067
С	0.45	0.60	0.017	0.024
C2	1.23	1.36	0.048	0.054
D	8.95	9.35	0.352	0.368
E	10.00	10.40	0.393	0.409
G	4.88	5.28	0.192	0.208
L	15.00	15.85	0.590	0.624
L2	1.27	1.40	0.050	0.055
L3	1.40	1.75	0.055	0.069
М	2.40	3.20	0.094	0.126
R	0.40	typ.	0.016	6 typ.
V2	0°	8°	0°	8°

Figure 13. Footprint (dimensions in mm)



Package information STTH30R04

2.2 DO-247 package information

Figure 14. DO-247 package outline

Table 7. DO-247 package mechanical data

			Dime	nsions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	4.85		5.15	0.191		0.203
D	2.20		2.60	0.086		0.102
E	0.40		0.80	0.015		0.031
F	1.00		1.40	0.039		0.055
F2		2.00			0.078	
F3	2.00		2.40	0.078		0.094
G		10.90			0.429	
Н	15.45		15.75	0.608		0.620
L	19.85		20.15	0.781		0.793
L1	3.70		4.30	0.145		0.169
L2		18.50			0.728	
L3	14.20		14.80	0.559		0.582
L4		34.60			1.362	
L5		5.50			0.216	
М	2.00		3.00	0.078		0.118
V		5°			5°	
V2		60°			60°	
Dia.	3.55		3.65	0.139		0.143

Package information STTH30R04

2.3 TO-220AC package information

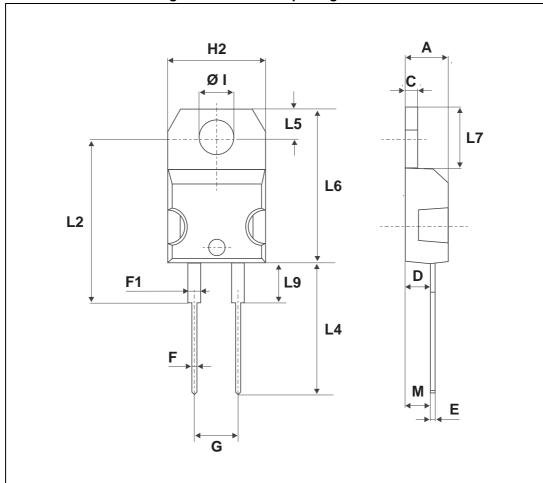


Figure 15. TO-220AC package outline

Table 8. TO-220AC package mechanical data

			Dimer	nsions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	4.40		4.60	0.173		0.181
С	1.23		1.32	0.048		0.051
D	2.40		2.72	0.094		0.107
Е	0.49		0.70	0.019		0.027
F	0.61		0.88	0.024		0.034
F1	1.14		1.70	0.044		0.066
G	4.95		5.15	0.194		0.202
H2	10.00		10.40	0.393		0.409
L2		16.4			0.645	
L4	13.00		14.00	0.511		0.551
L5	2.65		2.95	0.104		0.116
L6	15.25		15.75	0.600		0.620
L7	6.20		6.60	0.244		0.259
L9	3.50		3.93	0.137		0.154
М		2.6			0.102	
Diam. I	3.75		3.85	0.147		0.151

Ordering information STTH30R04

3 Ordering information

Table 9. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH30R04D	STTH30R04D	TO-220AC	1.86 g	50	Tube
STTH30R04G	STTH30R04G	D²PAK	1.48 g	50	Tube
STTH30R04G-TR	STTH30R04G	D²PAK	1.48 g	1000	Tape and reel
STTH30R04W	STTH30R04W	DO-247	4.40 g	30	Tube

4 Revision history

Table 10. Document revision history

Date	Revision	Description of changes
31-Mar-2007	1	First issue.
11-Dec-2015	2	Updated <i>Table 4</i> and reformatted to current standard. Removed DOP3I package information.

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